



GE Energy

Functional Testing Specification

*Parts & Repair Services
Louisville, KY*

LOU-GENEVA-IS200EHPA

Test Procedure for an IS200EHPA card.

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LOU-GENEVA-IS200EHPA REV. A	<div data-bbox="548 201 581 252" data-label="Image"></div> <div data-bbox="737 258 967 333" data-label="Text"> <p>GE Energy Part & Repair Services Louisville, KY</p> </div>	Page 2 of 3
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Functional test procedure for an IS200EGHPA card tested on the GENRAD® GENEVA system

1. SCOPE

1.1 This is a functional testing procedure for the IS200EHPA circuit board.

2. STANDARDS OF QUALITY

2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.

3.1.1 Check board's electronic folder for more information.

4. ENGINEERING REQUIREMENTS

4.1 Equipment Cleaning

4.1.1 Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.

4.2 Equipment Inspection

4.2.1 Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:

4.2.1.1 Wires broken or cracked

4.2.1.2 Terminal strips / connectors broken or cracked

4.2.1.3 Loose wires

4.2.1.4 Components visually damaged

4.2.1.5 Capacitors leaking

4.2.1.6 Solder joints damaged or cold

4.2.1.7 Circuit board burned or de-laminated

4.2.1.8 Printed wire runs burned or damaged

5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	H188912	GENRAD Geneva Test System
1	H190032	IS200EHPA Test Fixture #G57

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6. Testing Process

6.1 Setup

6.1.1 Install fixture H190032 onto Geneva test System.

6.1.2 Install UUT into test fixture.

6.2 Testing Procedure

6.2.1 Load appropriate test program and follow instructions on screen.

6.3 *TEST COMPLETE *****

7. Notes

7.1 Changes to the electronic GENEVA test are recorded in the following directory;

C:\Geneva Info\Geneva, file name is "Geneva Test Fixture Notes".

8. Attachments

8.1 None at this time.